

### TRENCHSTOP™ 5 WR5 technology in enhanced creepage and clearance package offers improved reliability against package contamination

#### Features

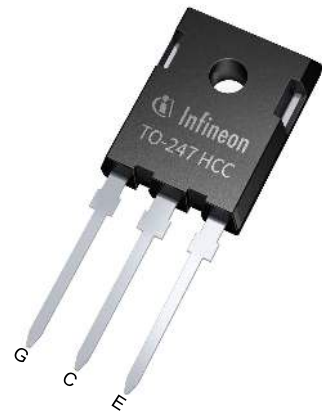
- $V_{CE} = 650\text{ V}$
- $I_C = 30\text{ A}$
- Pin-to-pin creepage distance  $> 4.8\text{ mm}$
- Pin-to-pin clearance distance  $> 3.4\text{ mm}$
- Monolithic diode optimized for PFC and welding applications
- Stable temperature behavior
- Very low  $V_{CEsat}$  and low  $E_{off}$
- Easy parallel switching capability based on positive temperature coefficient of  $V_{CEsat}$
- Low temperature dependence of  $V_{CEsat}$  and  $E_{sw}$
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

#### Potential applications

- PFC
- Welding
- ZCS applications

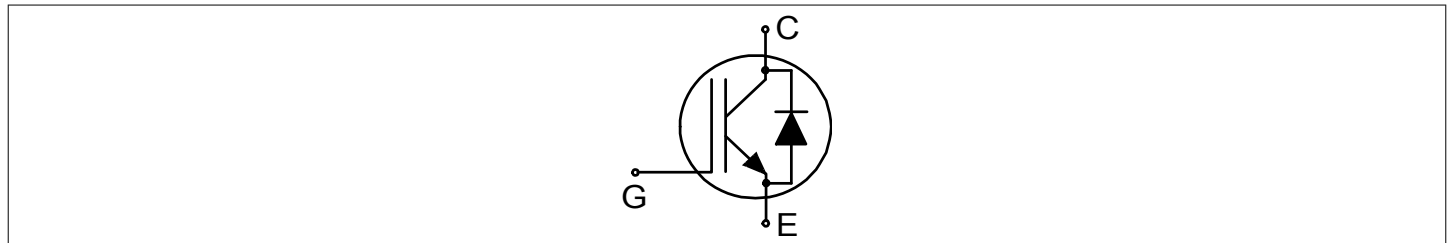
#### Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



- Lead-Free
- Green
- Halogen-Free
- RoHS

#### Description



| Type         | Package             | Marking |
|--------------|---------------------|---------|
| IKWH30N65WR5 | PG-TO247-3-STD-N4.8 | H30EWR5 |

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## 1 Package

**Table 1** Characteristic values

| Parameter  | Symbol        | Note or test condition                               | Values |      |      | Unit |
|--|---------------|--|--------|------|------|------|
|  |               |  | Min.   | Typ. | Max. |      |
| Internal emitter inductance measured 5 mm (0.197 in) from case | $L_E$         |  |        | 13.0 |      | nH   |
| Storage temperature  | $T_{stg}$     |  | -55    |      | 150  | °C   |
| Soldering temperature  |               | wave soldering 1.6 mm (0.063 in.) from case for 10 s |        |      | 260  | °C   |
| Mounting torque  | $M$           | M3 screw Maximum of mounting process: 3              |        |      | 0.6  | Nm   |
| Thermal resistance, junction-ambient                           | $R_{th(j-a)}$ |  |        |      | 40   | K/W  |

## 2 IGBT

**Table 2** Maximum rated values

| Parameter  | Symbol       | Note or test condition   | Values                | Unit |   |
|--|--------------|--|-----------------------|------|---|
| Collector-emitter voltage                              | $V_{CE}$     | $T_{vj} \geq 25\text{ °C}$   | 650                   | V    |   |
| DC collector current, limited by $T_{vjmax}$           | $I_C$        |  | $T_c = 25\text{ °C}$  | 75   | A |
|  |              |  | $T_c = 100\text{ °C}$ | 49   |   |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$ | $I_{Cpulse}$ |  | 90                    | A    |   |
| Turn-off safe operating area                           |              | $V_{CE} \leq 650\text{ V}$ , $t_p \leq 1\text{ }\mu\text{s}$ , $T_{vj} \leq 175\text{ °C}$ | 90                    | A    |   |
| Gate-emitter voltage                                   | $V_{GE}$     |  | $\pm 20$              | V    |   |
| Transient gate-emitter voltage                         | $V_{GE}$     | $t_p \leq 10\text{ }\mu\text{s}$ , $D < 0.01$  | $\pm 30$              | V    |   |
| Power dissipation                                      | $P_{tot}$    |  | $T_c = 25\text{ °C}$  | 190  | W |
|  |              |  | $T_c = 100\text{ °C}$ | 95   |   |

**Table 3** Characteristic values

| Parameter                            | Symbol      | Note or test condition                        | Values                   |      |      | Unit |
|--------------------------------------|-------------|---|--------------------------|------|------|------|
|                                      |             |   | Min.                     | Typ. | Max. |      |
| Collector-emitter breakdown voltage  | $V_{BRCES}$ | $I_C = 0.2\text{ mA}$ , $V_{GE} = 0\text{ V}$ | 650                      |      |      | V    |
| Collector-emitter saturation voltage | $V_{CEsat}$ | $I_C = 30\text{ A}$ , $V_{GE} = 15\text{ V}$  | $T_{vj} = 25\text{ °C}$  | 1.4  | 1.7  | V    |
|                                      |             |   | $T_{vj} = 175\text{ °C}$ | 1.65 |      |      |
| Gate-emitter threshold voltage       | $V_{GEth}$  | $I_C = 0.3\text{ mA}$ , $V_{CE} = V_{GE}$     | 3.2                      | 4    | 4.8  | V    |

(table continues...)  
 Datasheet

Table 3 (continued) Characteristic values

| Parameter                           | Symbol     | Note or test condition   | Values  |      |      | Unit          |
|-------------------------------------|------------|--|---|------|------|---------------|
|                                     |            |  | Min.  | Typ. | Max. |               |
| Zero gate-voltage collector current | $I_{CES}$  | $V_{CE} = 650 \text{ V}, V_{GE} = 0 \text{ V}$   | $T_{vj} = 25 \text{ }^\circ\text{C}$                      |      | 40   | $\mu\text{A}$ |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}$                     |      | 0.5  | $\text{mA}$   |
| Gate-emitter leakage current        | $I_{GES}$  | $V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$  |   |      | 100  | $\text{nA}$   |
| Transconductance                    | $g_{fs}$   | $I_C = 30 \text{ A}, V_{CE} = 20 \text{ V}$  |   | 67   |      | $\text{S}$    |
| Input capacitance                   | $C_{ies}$  | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 3230 |      | $\text{pF}$   |
| Output capacitance                  | $C_{oes}$  | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 32   |      | $\text{pF}$   |
| Reverse transfer capacitance        | $C_{res}$  | $V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 100 \text{ kHz}$   |   | 13   |      | $\text{pF}$   |
| Gate charge                         | $Q_G$      | $I_C = 30 \text{ A}, V_{GE} = 15 \text{ V}, V_{CC} = 520 \text{ V}$  |   | 133  |      | $\text{nC}$   |
| Turn-on delay time                  | $t_{don}$  | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 41   | $\text{ns}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 33   |               |
| Rise time (inductive load)          | $t_r$      | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 20   | $\text{ns}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 21   |               |
| Turn-off delay time                 | $t_{doff}$ | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 398  | $\text{ns}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 458  |               |
| Fall time (inductive load)          | $t_f$      | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 18   | $\text{ns}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 18   |               |
| Turn-on energy                      | $E_{on}$   | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 0.87 | $\text{mJ}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 1.04 |               |
| Turn-off energy                     | $E_{off}$  | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 0.4  | $\text{mJ}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 0.7  |               |
| Total switching energy              | $E_{ts}$   | $V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_{Gon} = 27 \text{ } \Omega, R_{Goff} = 27 \text{ } \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 28 \text{ pF}$ | $T_{vj} = 25 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$  |      | 1.27 | $\text{mJ}$   |
|                                     |            |  | $T_{vj} = 175 \text{ }^\circ\text{C}, I_C = 30 \text{ A}$ |      | 1.74 |               |

(table continues...)

Table 3 (continued) Characteristic values

| Parameter                                 | Symbol     | Note or test condition | Values |      |      | Unit |
|---|------------|------------------------|--------|------|------|------|
|   |            |                        | Min.   | Typ. | Max. |      |
| IGBT thermal resistance, junction to case | $R_{thjc}$ |                        |        |      | 0.8  | K/W  |
| Operating junction temperature            | $T_{vj}$   |                        | -40    |      | 175  | °C   |

Note: Electrical Characteristic, at  $T_{vj} = 25^{\circ}\text{C}$ , unless otherwise specified.

### 3 Diode

Table 4 Maximum rated values

| Parameter                                     | Symbol       | Note or test condition           | Values                      | Unit |   |
|---|--------------|----------------------------------|-----------------------------|------|---|
| Repetitive peak reverse voltage               | $V_{RRM}$    | $T_{vj} \geq 25^{\circ}\text{C}$ | 650                         | V    |   |
| Diode forward current, limited by $T_{vjmax}$ | $I_F$        |                                  | $T_c = 25^{\circ}\text{C}$  | 23   | A |
|   |              |                                  | $T_c = 100^{\circ}\text{C}$ | 13   |   |
| Diode pulsed current, limited by $T_{vjmax}$  | $I_{Fpulse}$ |                                  | 45                          | A    |   |

Table 5 Characteristic values

| Parameter                                  | Symbol     | Note or test condition | Values  |      |      | Unit          |
|--|------------|------------------------|---|------|------|---------------|
|  |            |                        | Min.  | Typ. | Max. |               |
| Diode forward voltage                      | $V_F$      | $I_F = 12\text{ A}$    | $T_{vj} = 25^{\circ}\text{C}$   | 1.3  | 1.6  | V             |
|  |            |                        | $T_{vj} = 175^{\circ}\text{C}$  | 1.35 |      |               |
| Diode reverse recovery charge              | $Q_{rr}$   | $V_R = 400\text{ V}$   | $T_{vj} = 25^{\circ}\text{C}$ ,<br>$I_F = 15\text{ A}$ ,<br>$-di_F/dt = 1400\text{ A}/\mu\text{s}$  | 1.9  |      | $\mu\text{C}$ |
|  |            |                        | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$I_F = 15\text{ A}$ ,<br>$-di_F/dt = 1300\text{ A}/\mu\text{s}$ | 2.6  |      |               |
| Diode peak reverse recovery current        | $I_{rrm}$  | $V_R = 400\text{ V}$   | $T_{vj} = 25^{\circ}\text{C}$ ,<br>$I_F = 15\text{ A}$ ,<br>$-di_F/dt = 1400\text{ A}/\mu\text{s}$  | 28.6 |      | A             |
|  |            |                        | $T_{vj} = 175^{\circ}\text{C}$ ,<br>$I_F = 15\text{ A}$ ,<br>$-di_F/dt = 1300\text{ A}/\mu\text{s}$ | 39   |      |               |
| Diode thermal resistance, junction to case | $R_{thjc}$ |                        |   |      | 3.3  | K/W           |

(table continues...)

**Table 5** (continued) Characteristic values

| Parameter                      | Symbol   | Note or test condition | Values |      |      | Unit |
|--------------------------------|----------|------------------------|--------|------|------|------|
|                                |          |                        | Min.   | Typ. | Max. |      |
| Operating junction temperature | $T_{vj}$ |                        | -40    |      | 175  | °C   |

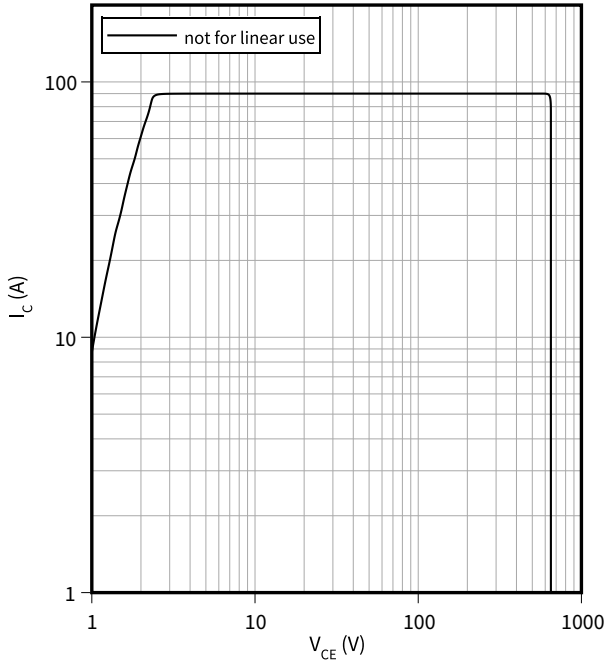
*Note:* For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

## 4 Characteristics diagrams

### Reverse bias safe operating area

$$I_C = f(V_{CE})$$

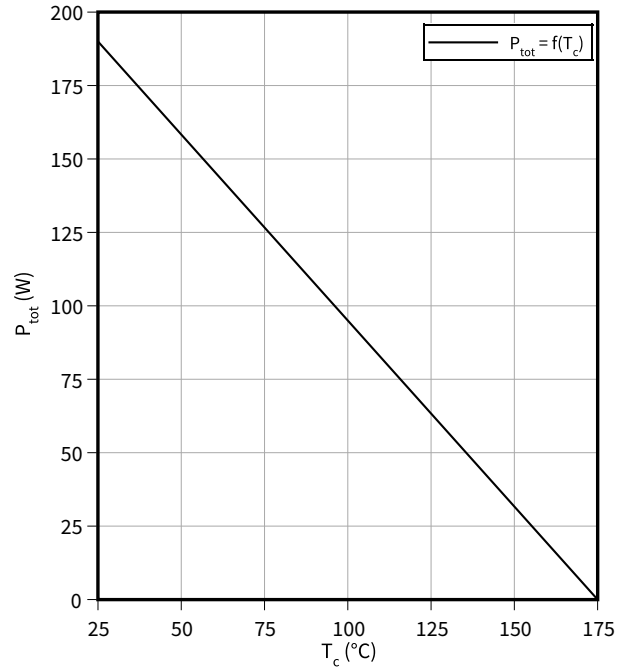
$t_p = 1 \mu s, D = 0, T_{vj} \leq 175 \text{ }^\circ\text{C}, T_c = 25 \text{ }^\circ\text{C}, V_{GE} = 15 \text{ V}$



### Power dissipation as a function of case temperature

$$P_{tot} = f(T_c)$$

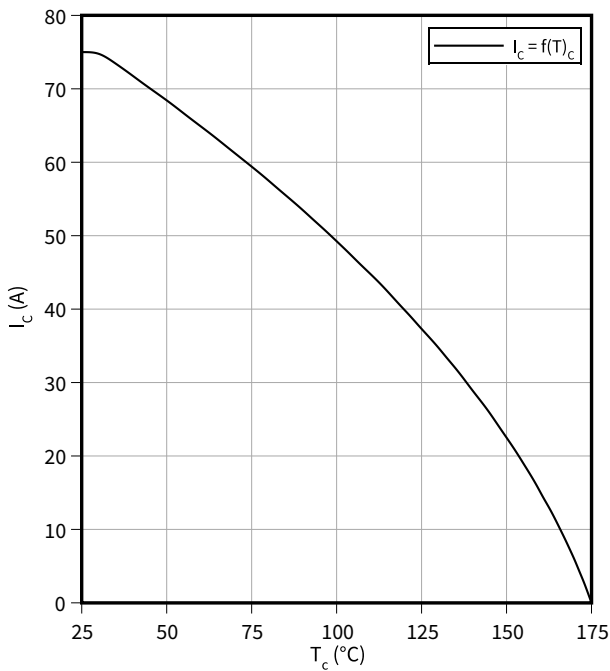
$T_{vj} \leq 175 \text{ }^\circ\text{C}$



### Collector current as a function of case temperature

$$I_C = f(T_c)$$

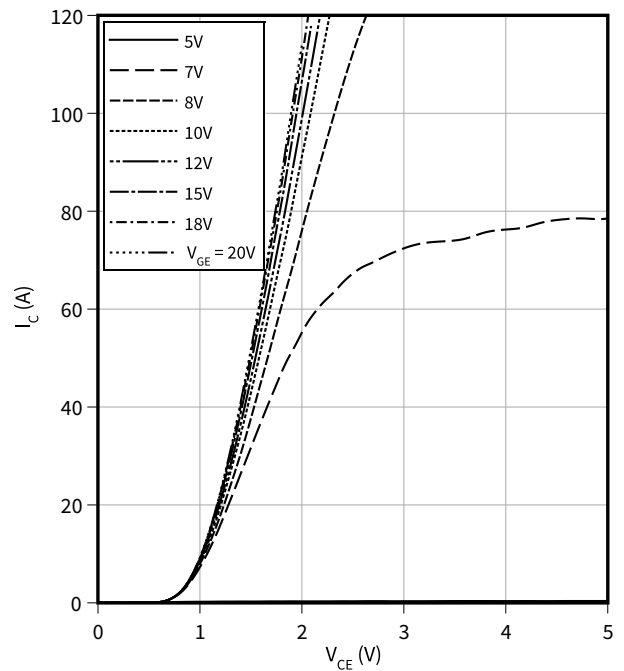
$T_{vj} \leq 175 \text{ }^\circ\text{C}, V_{GE} \geq 15 \text{ V}$



### Typical output characteristic

$$I_C = f(V_{CE})$$

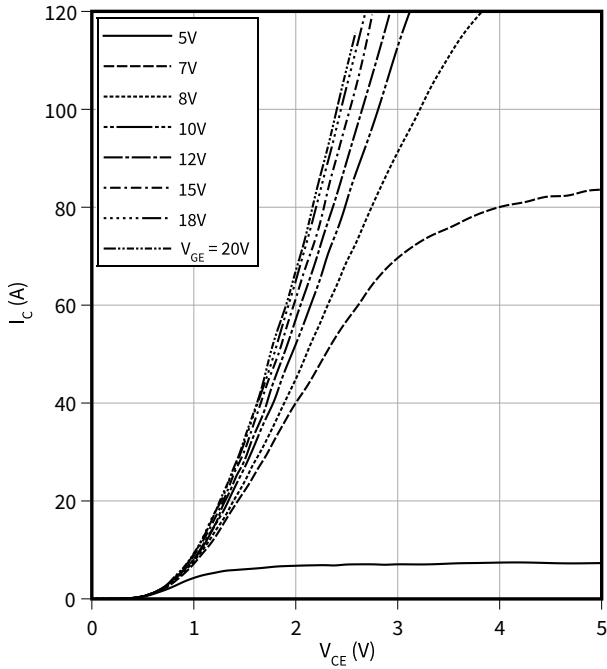
$T_{vj} = 25 \text{ }^\circ\text{C}$



4 Characteristics diagrams

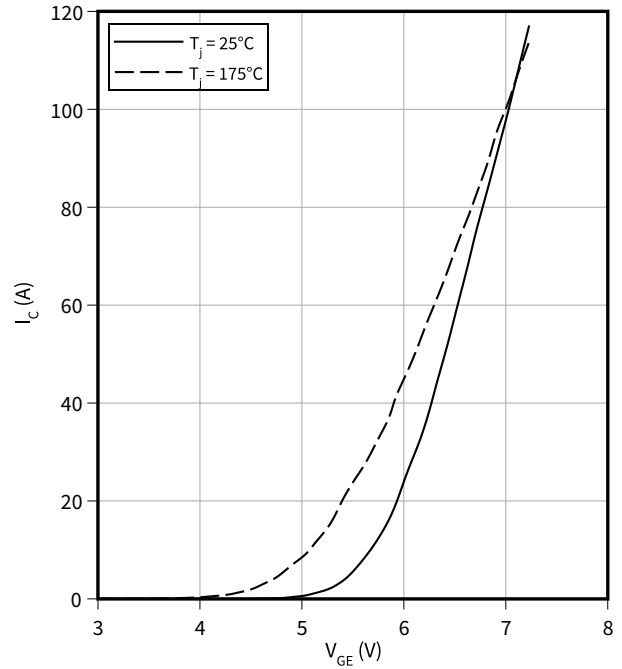
**Typical output characteristic**

$I_C = f(V_{CE})$   
 $T_{vj} = 175\text{ °C}$



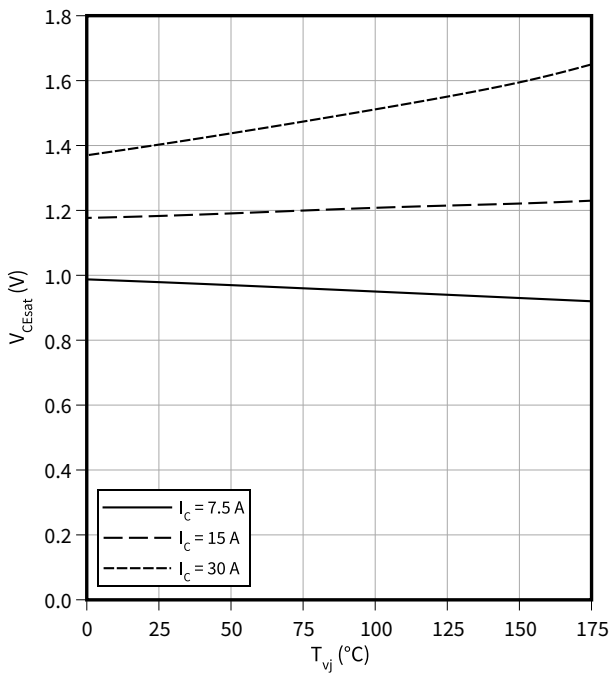
**Typical transfer characteristic**

$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



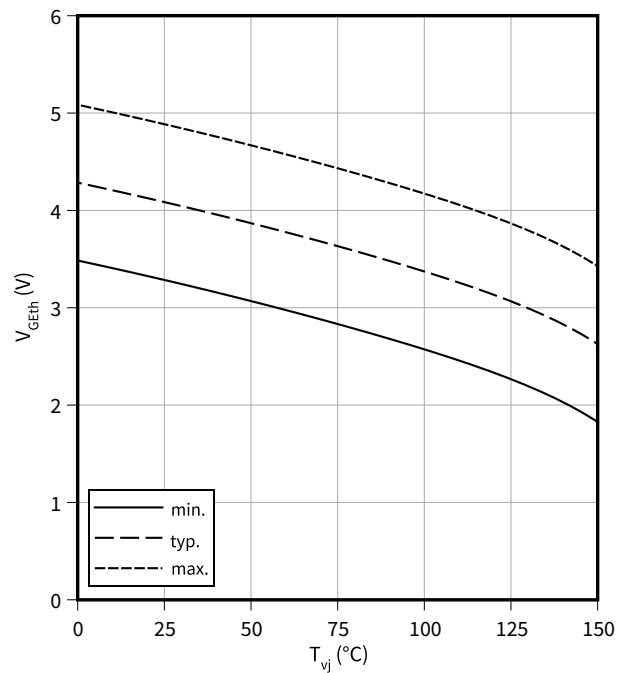
**Typical collector-emitter saturation voltage as a function of junction temperature**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15\text{ V}$



**Gate-emitter threshold voltage as a function of junction temperature**

$V_{GEth} = f(T_{vj})$   
 $I_C = 0.2\text{ mA}$



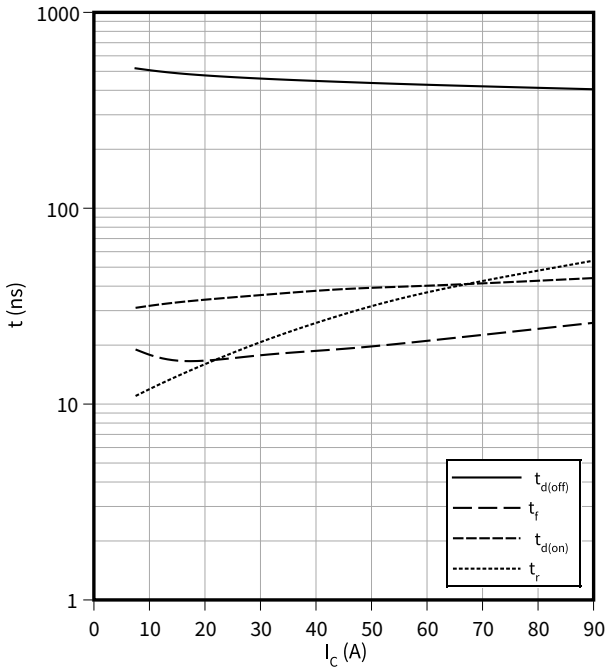


4 Characteristics diagrams

**Typical switching times as a function of collector current**

$t = f(I_C)$

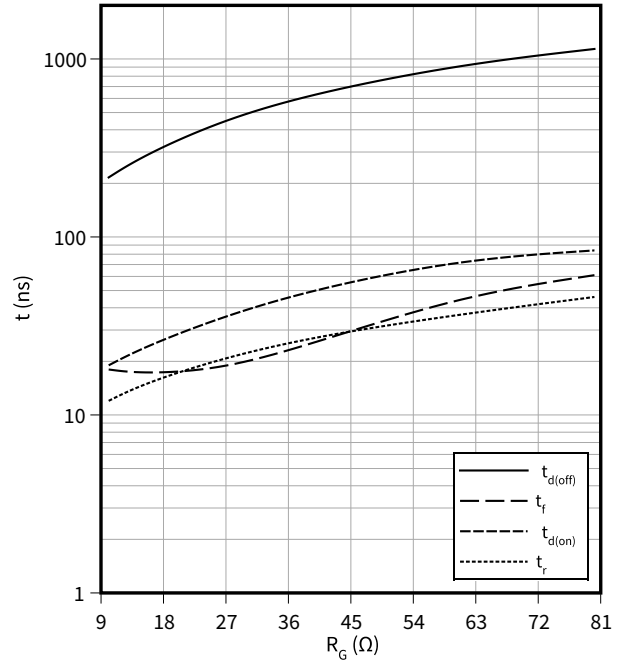
$V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ }\Omega$



**Typical switching times as a function of gate resistor**

$t = f(R_G)$

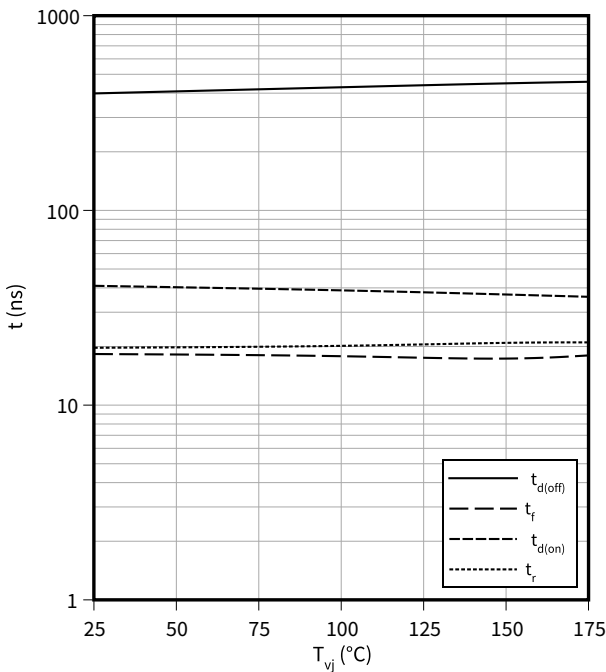
$I_C = 30\text{ A}, V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$



**Typical switching times as a function of junction temperature**

$t = f(T_{vj})$

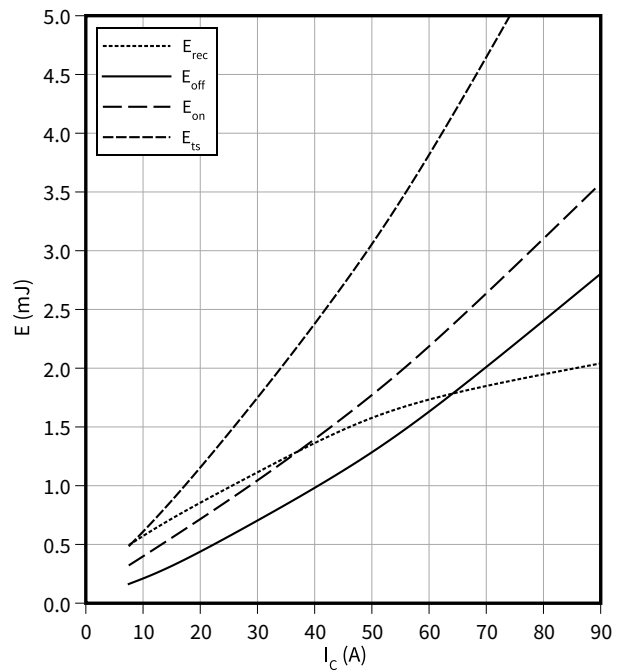
$I_C = 30\text{ A}, V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ }\Omega$



**Typical switching energy losses as a function of collector current**

$E = f(I_C)$

$V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ }\Omega$

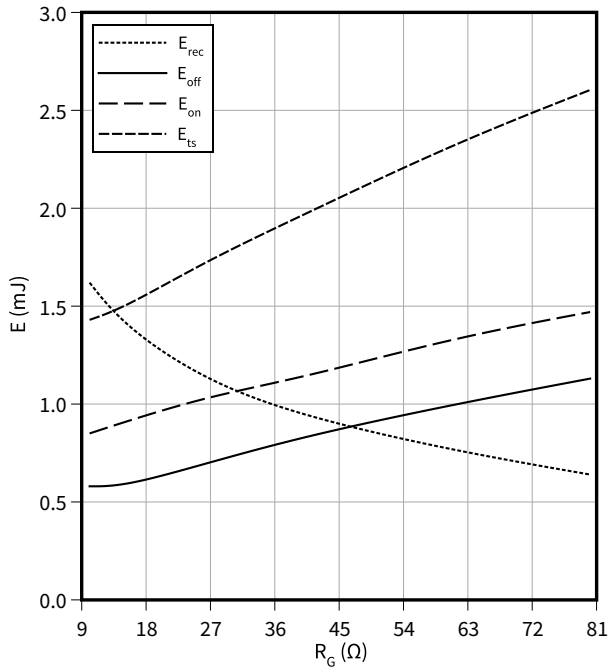


4 Characteristics diagrams

**Typical switching energy losses as a function of gate resistor**

$E = f(R_G)$

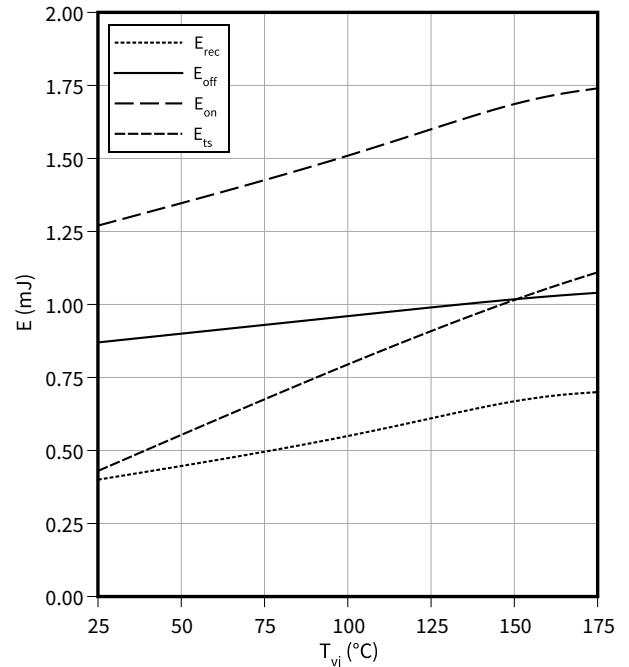
$I_C = 30\text{ A}, V_{CC} = 400\text{ V}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}$



**Typical switching energy losses as a function of junction temperature**

$E = f(T_{vj})$

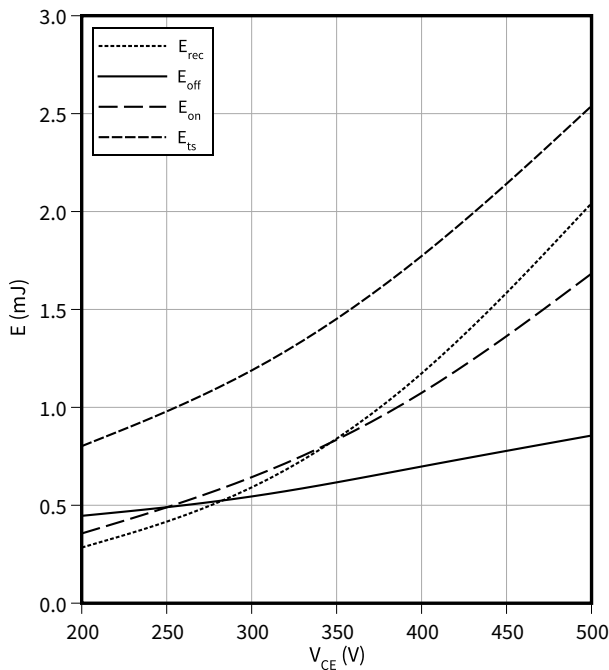
$I_C = 30\text{ A}, V_{CC} = 400\text{ V}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ Ω}$



**Typical switching energy losses as a function of collector emitter voltage**

$E = f(V_{CE})$

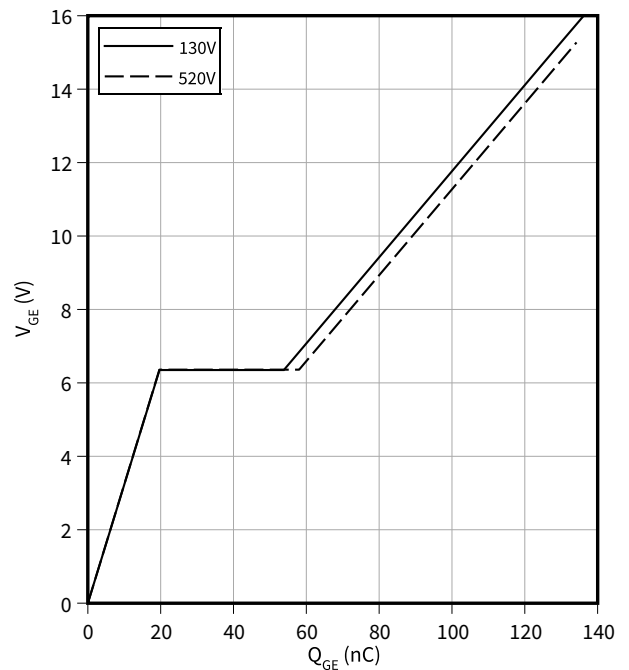
$I_C = 30\text{ A}, T_{vj} = 175\text{ °C}, V_{GE} = 0/15\text{ V}, R_G = 27\text{ Ω}$



**Typical gate charge**

$V_{GE} = f(Q_{GE})$

$I_C = 30\text{ A}$

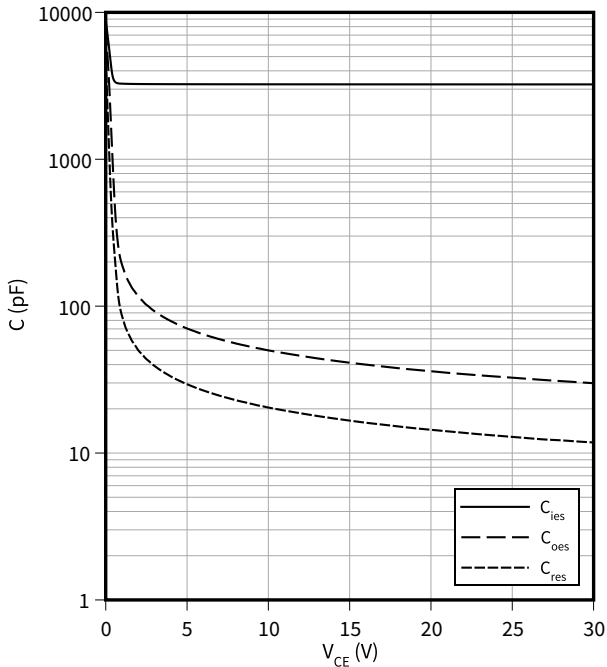


4 Characteristics diagrams

**Typical capacitance as a function of collector-emitter voltage**

$C = f(V_{CE})$

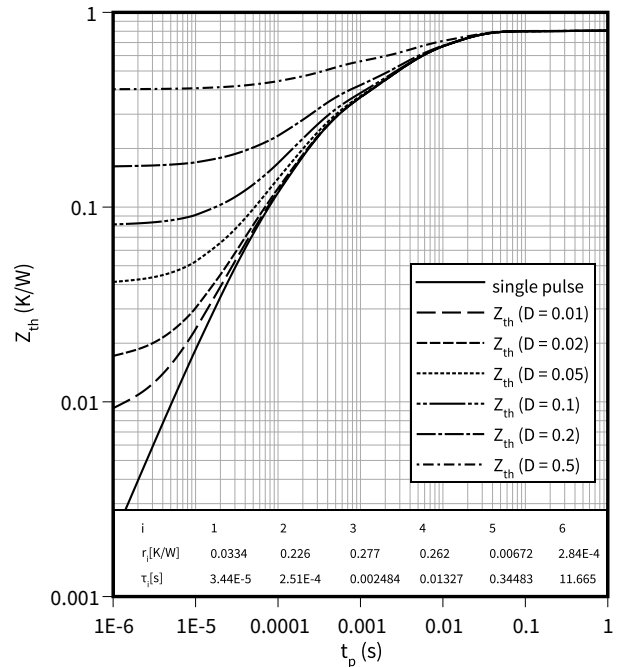
$V_{GE} = 0\text{ V}, f = 100\text{ kHz}$



**IGBT transient thermal impedance as a function of pulse width**

$Z_{th} = f(t_p)$

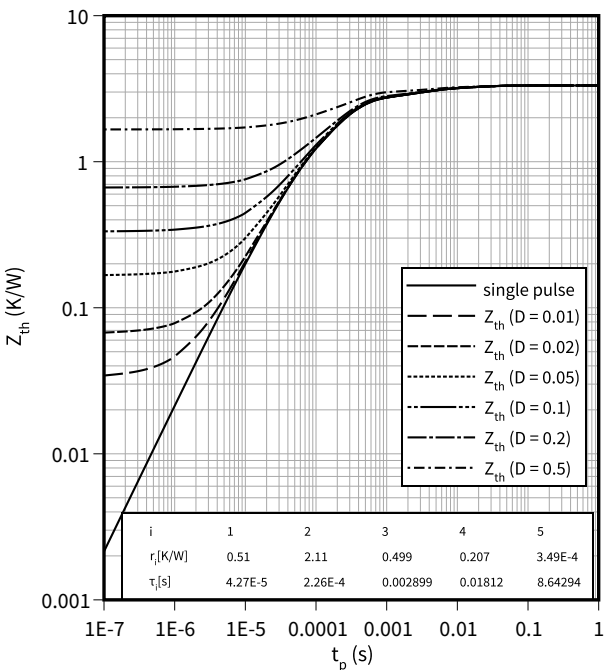
$D = t_p/T$



**Diode transient thermal impedance as a function of pulse width**

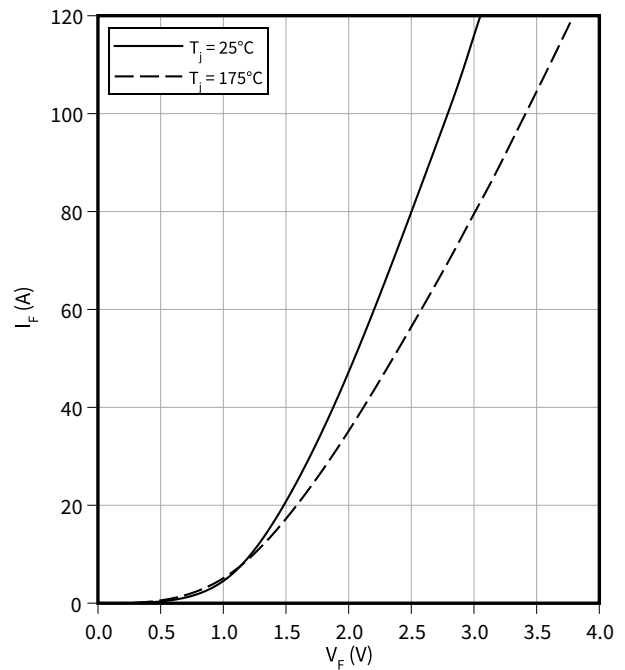
$Z_{th} = f(t_p)$

$D = t_p/T$



**Typical diode forward current as a function of forward voltage**

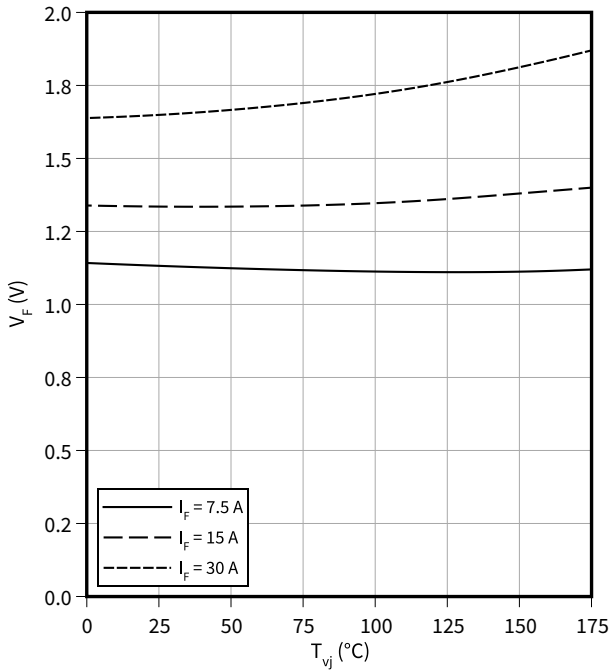
$I_F = f(V_F)$



4 Characteristics diagrams

**Typical diode forward voltage as a function of junction temperature**

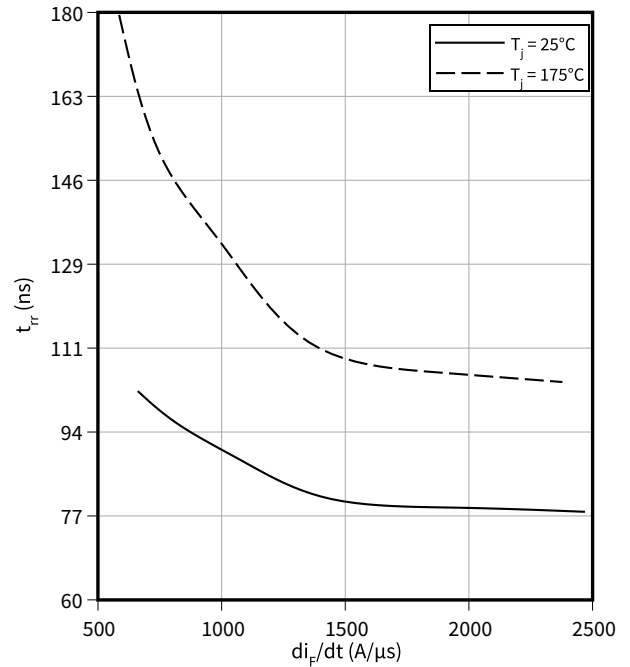
$V_F = f(T_{vj})$



**Typical reverse recovery time as a function of diode current slope**

$t_{rr} = f(di_F/dt)$

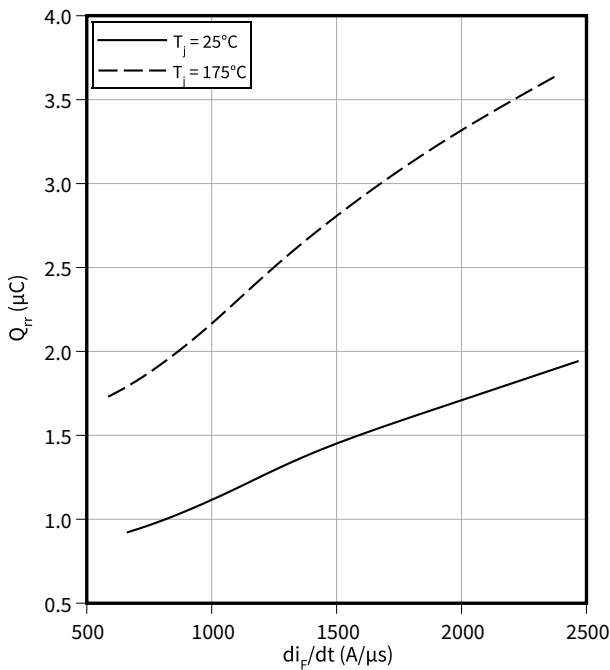
$V_R = 400$  V,  $I_F = 15$  A



**Typical reverse recovery charge as a function of diode current slope**

$Q_{rr} = f(di_F/dt)$

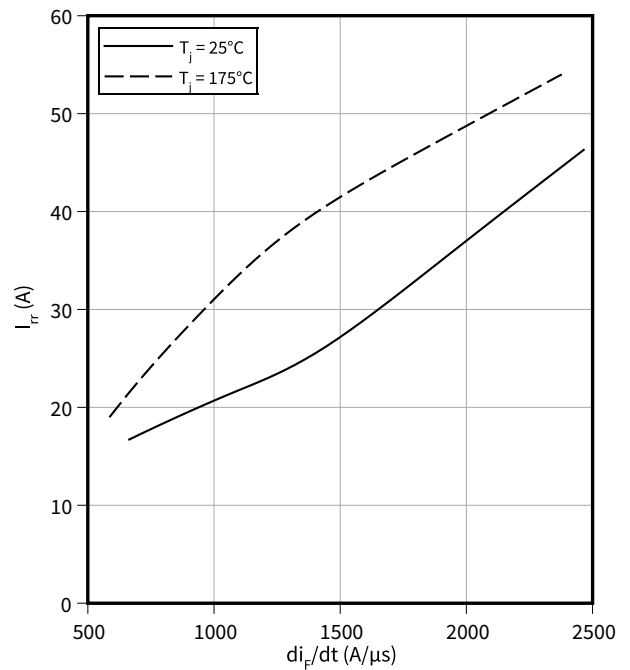
$V_R = 400$  V,  $I_F = 15$  A



**Typical reverse recovery current as a function of diode current slope**

$I_{rr} = f(di_F/dt)$

$V_R = 400$  V,  $I_F = 15$  A

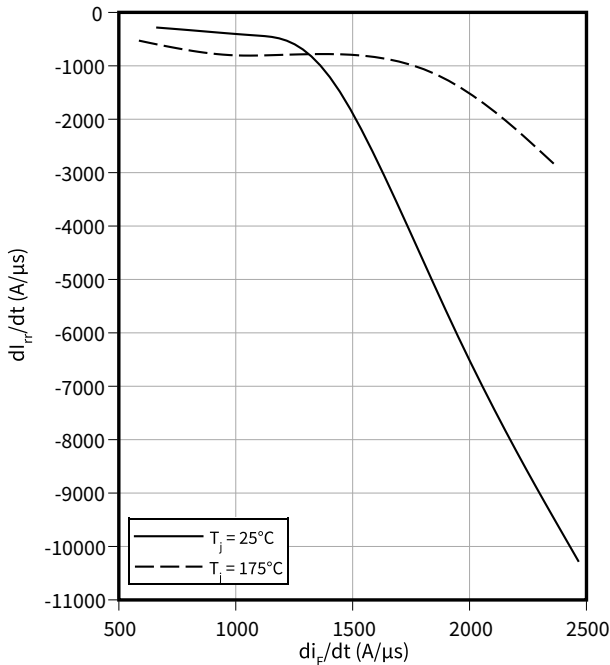


4 Characteristics diagrams

**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

$di_{rr}/dt = f(di_F/dt)$

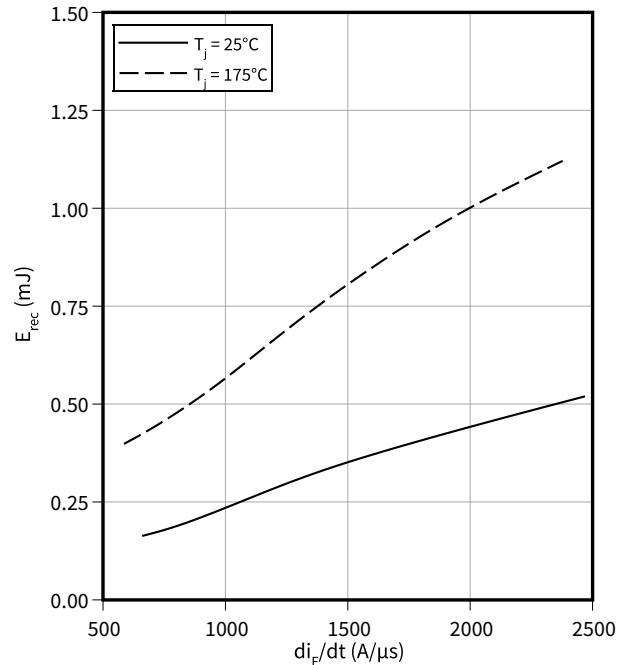
$V_R = 400\text{ V}, I_F = 15\text{ A}$



**Typical reverse energy losses as a function of diode current slope**

$E_{rec} = f(di_F/dt)$

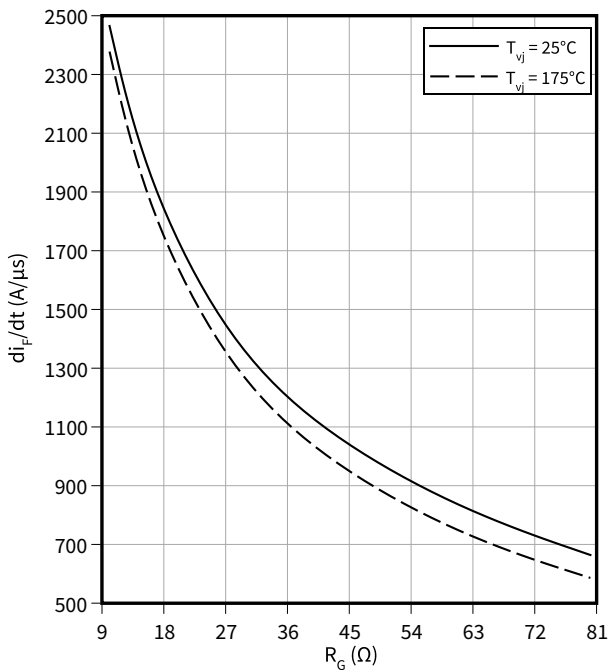
$V_R = 400\text{ V}, I_F = 15\text{ A}$



**Typical diode current slope as a function of gate resistor**

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}, I_F = 15\text{ A}$



5 Package outlines

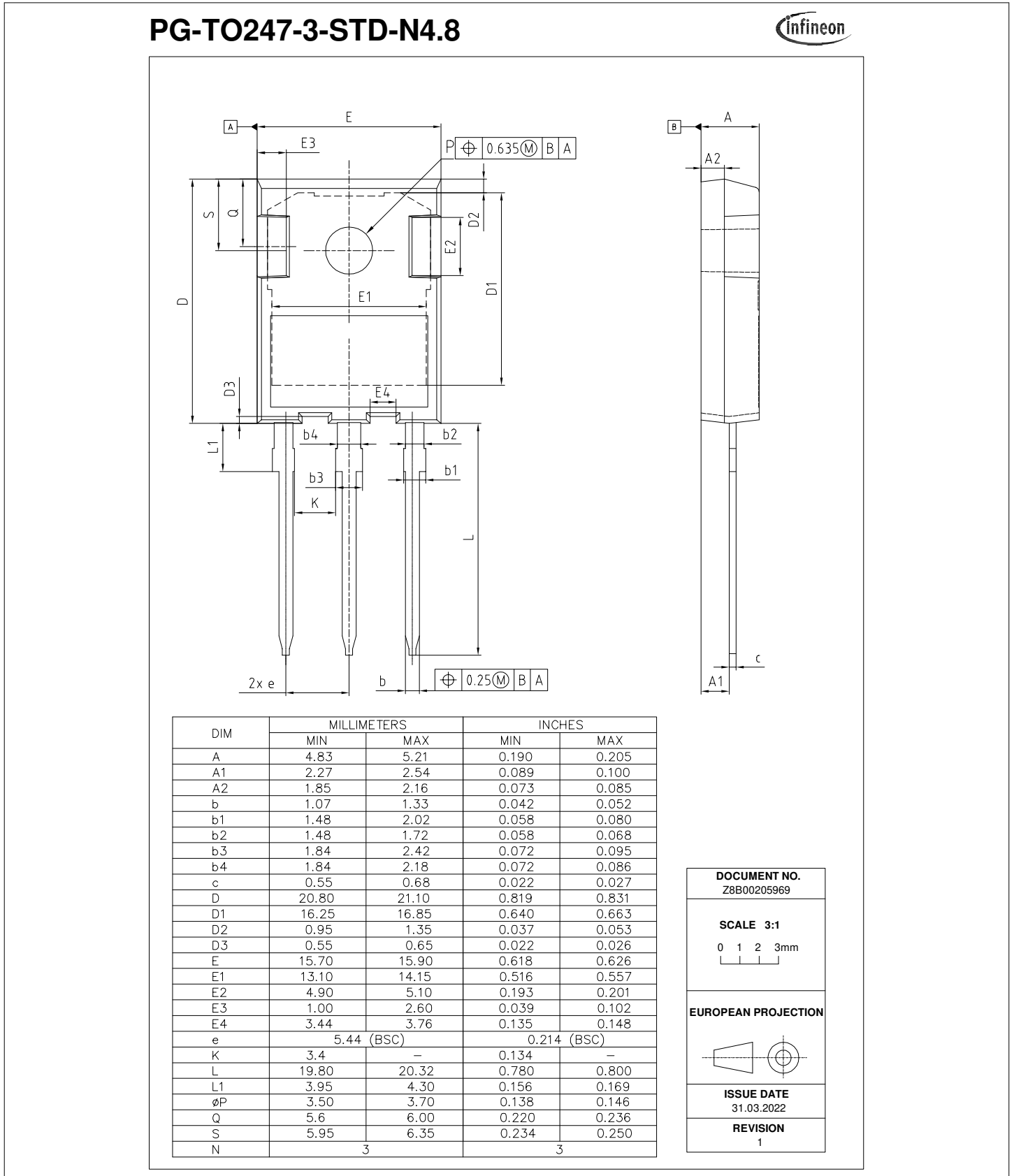


Figure 1

## 6 Testing conditions

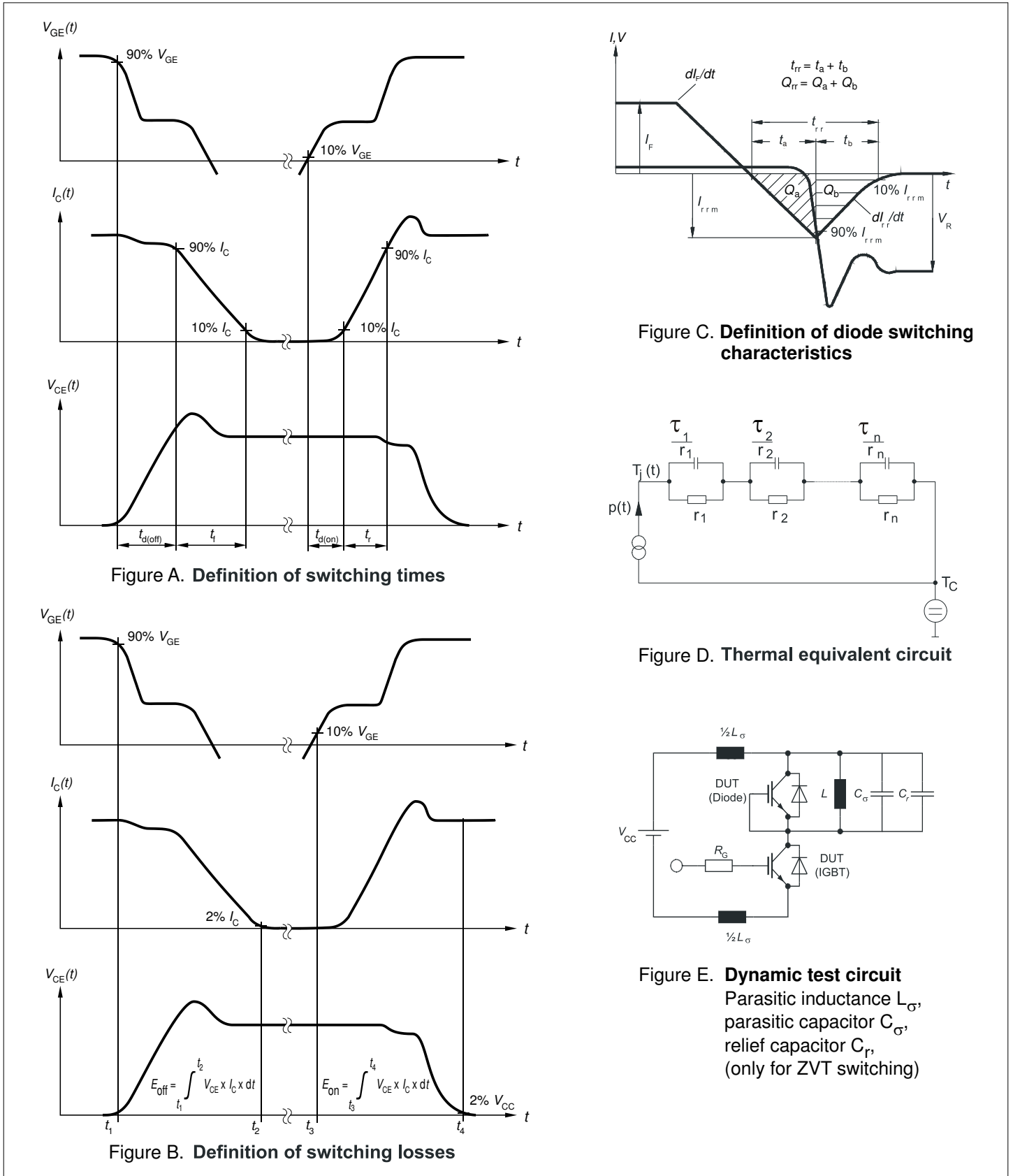


Figure 2

## Revision history

| Document revision | Date of release | Description of changes  |
|-------------------|-----------------|---|
| 1.00              | 2021-05-17      | Final datasheet   |
| 1.10              | 2021-05-18      | Update of diagram $E = f(T_{vj})$   |
| 1.20              | 2021-06-29      | Update of diagram $E = f(T_{vj})$   |
| 1.30              | 2022-04-05      | <p>Update of “DC collector current, limited by <math>T_{vjmax}</math>” in table “Maximum rated values”, for 25°C and 100°C</p> <p>Transient gate-emitter voltage <math>V_{GE}</math> in table “Maximum rated values” of IGBT changed to <math>\pm 30V</math></p> <p>Update of diagram “Collector current as a function of case temperature”, <math>I_C = f(T_c)</math></p> <p>“Forward bias safe operating area” diagram renamed to “Reverse bias safe operating area”</p> <p>Correction of package outline dimensions</p> <p>Change package name to marketing name</p> |



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